



BUL416

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- n STMicroelectronics PREFERRED SALES TYPE
- n NPN TRANSISTOR
- n HIGH VOLTAGE CAPABILITY
- n VERY HIGH SWITCHING SPEED
- n FULLY CHARACTERIZED AT 125 °C
- n LOW SPREAD OF DYNAMIC PARAMETERS

APPLICATIONS

- n ELECTRONIC BALLAST FOR FLUORESCENT LIGHTING
- n SWITCH MODE POWER SUPPLIES

DESCRIPTION

The device is manufactured using high voltage Multi-Epitaxial Mesa technology for cost-effective high performance. It uses a Hollow Emitter structure to enhance switching speeds.

The BUL series is designed for use in lighting applications and low cost switch-mode power supplies.

Figure 1: Package

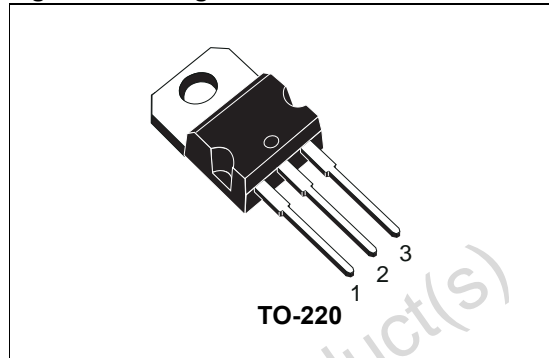


Figure 2: Internal Schematic Diagram

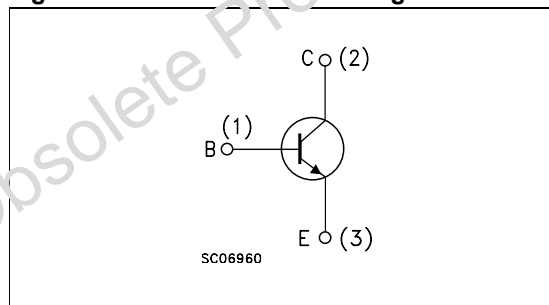


Table 1: Order Codes

Part Number	Marking	Package	Packaging
BUL416	BUL416A or (#) BUL416B	TO-220	Tube

See note on page 2

Table 2: Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage ($V_{BE} = 0$)	1600	V
V_{CEO}	Collector-Emitter Voltage ($I_B = 0$)	800	V
V_{EBO}	Emitter-Base Voltage ($I_C = 0$)	9	V
I_C	Collector Current	6	A
I_{CM}	Collector Peak Current ($t_p < 5ms$)	9	A
I_B	Base Current	5	A
I_{BM}	Base Peak Current ($t_p < 5ms$)	8	A
P_{tot}	Total Dissipation at $T_C = 25\text{ °C}$	110	W
T_{stg}	Storage Temperature	-65 to 150	°C

BUL416

Symbol	Parameter	Value	Unit
T_J	Max. Operating Junction Temperature	150	°C

Table 3: Thermal Data

$R_{thj-case}$	Thermal Resistance Junction-Case	Max	1.14	°C/W
$R_{thj-amb}$	Thermal Resistance Junction-Ambient	Max	62.5	°C/W

Table 4: Electrical Characteristics ($T_{case} = 25\text{ °C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CES}	Collector Cut-off Current ($V_{BE} = 0\text{ V}$)	$V_{CE} = 1600\text{ V}$			100	μA
		$V_{CE} = 1600\text{ V}$	$T_J = 125\text{ °C}$		500	μA
I_{CEO}	Collector Cut-off Current ($I_B = 0$)	$V_{CE} = 800\text{ V}$			250	μA
$V_{CEO(sus)}^*$	Collector-Emitter Sustaining Voltage ($I_B = 0$)	$I_C = 100\text{ mA}$ $L = 25\text{ mH}$	800			V
V_{EBO}	Emitter-Base Voltage ($I_C = 0$)	$I_E = 10\text{ mA}$	9			V
$V_{CE(sat)}^*$	Collector-Emitter Saturation Voltage	$I_C = 2\text{ A}$ $I_B = 0.4\text{ A}$			1.5	V
		$I_C = 4\text{ A}$ $I_B = 1.33\text{ A}$			3	V
$V_{BE(sat)}^*$	Base-Emitter Saturation Voltage	$I_C = 2\text{ A}$ $I_B = 0.4\text{ A}$			1.2	V
		$I_C = 4\text{ A}$ $I_B = 1.33\text{ A}$			1.5	V
h_{FE}^*	DC Current Gain	$I_C = 10\text{ mA}$ $V_{CE} = 5\text{ V}$	10			
		$I_C = 0.7\text{ A}$ $V_{CE} = 5\text{ V}$	12		27	
		Group A Group B	25		40	
t_s t_f	INDUCTIVE LOAD Storage Time Fall Time	$I_C = 3\text{ A}$ $I_{B1} = 1\text{ A}$ $V_{BE(off)} = -5\text{ V}$ $R_{BB} = 0\ \Omega$ $V_{clamp} = 200\text{ V}$ $L = 200\ \mu\text{H}$ (see figure 12)		2.3 650		μs ns
		$I_C = 3\text{ A}$ $I_{B1} = 1\text{ A}$ $V_{BE(off)} = -5\text{ V}$ $R_{BB} = 0\ \Omega$ $V_{clamp} = 200\text{ V}$ $L = 200\ \mu\text{H}$ $T_J = 100\text{ °C}$ (see figure 12)		3 680		μs ns

* Pulsed: Pulsed duration = 300 μs , duty cycle $\leq 1.5\%$.

Note: Product is pre-selected in DC current gain (Group A and Group B). STMicroelectronics reserves the right to ship either groups according to production availability. Please contact your nearest STMicroelectronics sales office for delivery details.

Figure 3: Safe Operating Area

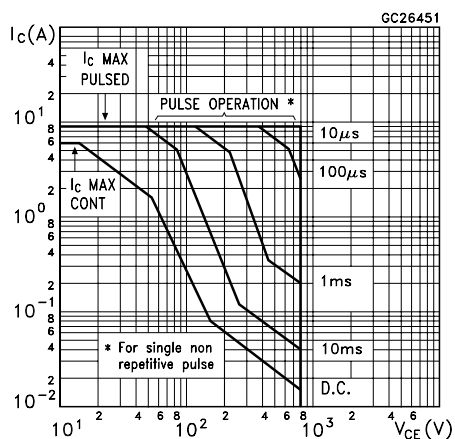


Figure 4: DC Current Gain

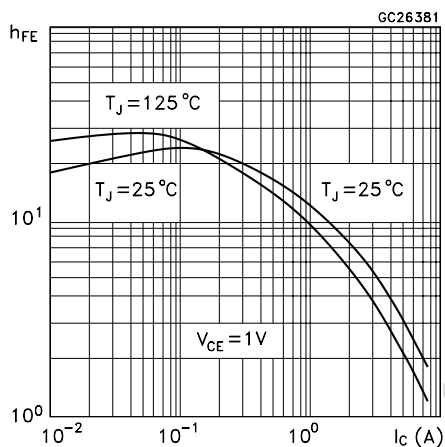


Figure 5: Collector-Emitter Saturation Voltage

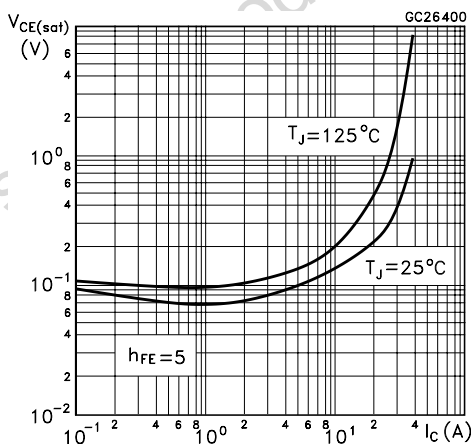


Figure 6: Derating Curve

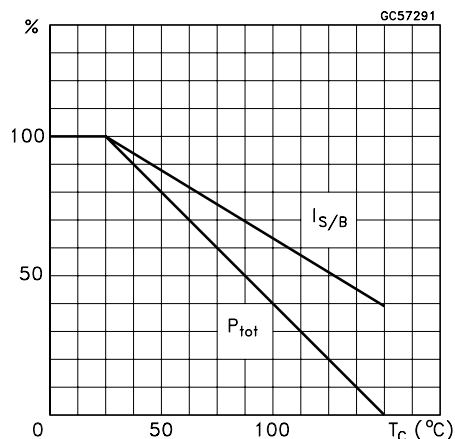


Figure 7: DC Current Gain

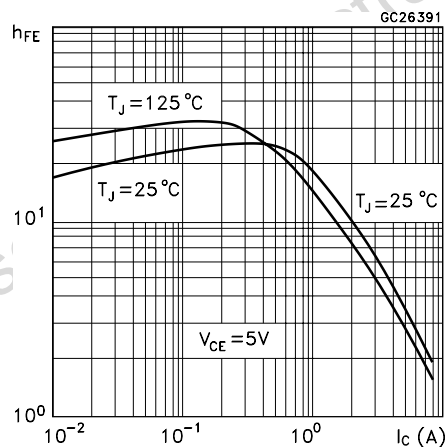


Figure 8: Base-Emitter Saturation Voltage

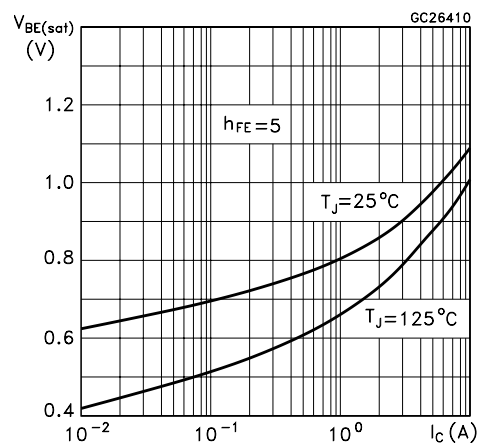


Figure 9: Inductive Load Fall Time

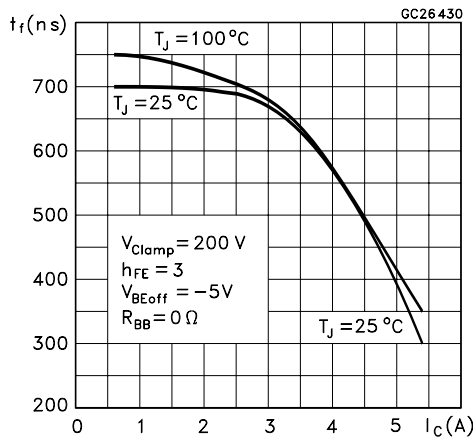


Figure 11: Resistive Load Storage Time

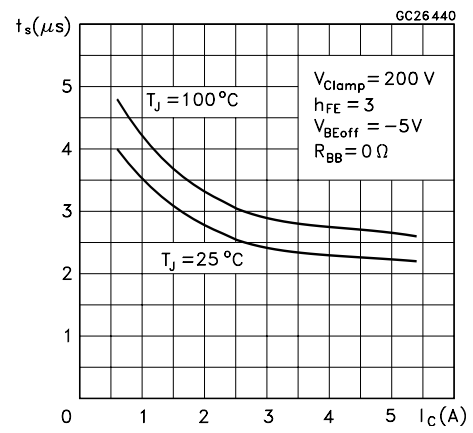


Figure 10: Reverse Biased SOA

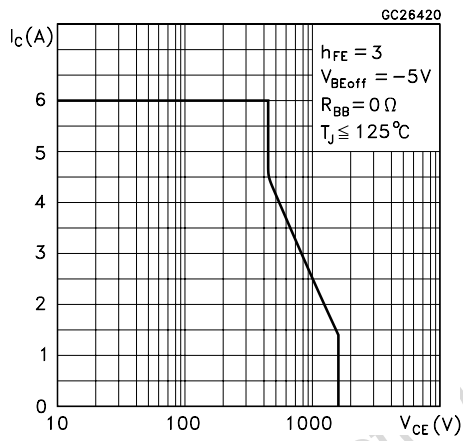


Figure 12: Inductive Load Switching Test Circuit

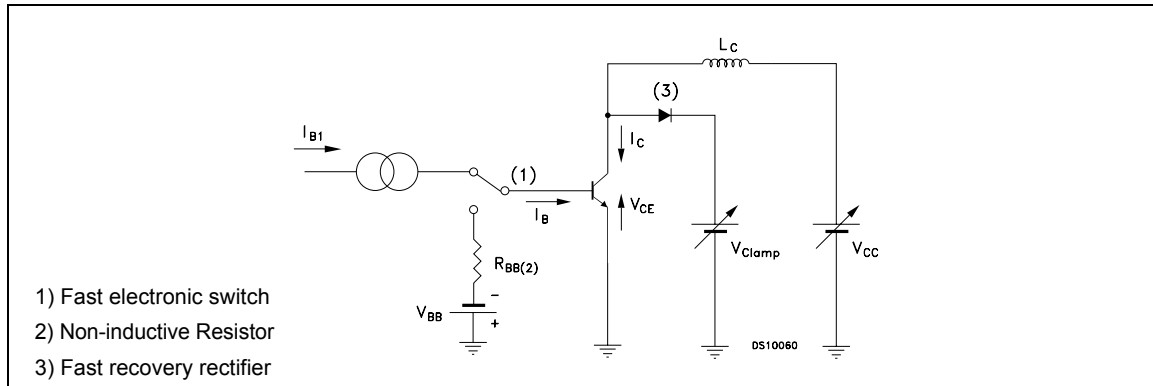


Table 5:

Version	Release Date	Change Designator
14-Jan-2004	1	First Release.
09-Sep-2004	2	Second Release.
26-Jan-2005	3	Third Release.

Obsolete Product(s) - Obsolete Product(s)

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